



KPG-5045US

PATENT

2854

115  
12/19/02  
M. Ludge

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Kitson : Art Unit: 2854  
Serial No.: 10/044,261 : Examiner: Unknown  
Filed: January 10, 2002 :  
For: METHOD OF MANUFACTURING A :  
THERMALLY IMAGEABLE :  
ELEMENT

INFORMATION DISCLOSURE STATEMENT

Assistant Commissioner for Patents  
Washington, D.C. 20231

SIR:

Pursuant to 37 C.F.R. §§ 1.97 and 1.98 and to the duty of disclosure set forth in 37 C.F.R. § 1.56, the Examiner in charge of the above-identified application is requested to consider and make of record the references listed on the PTO 1449 (R&P) submitted herewith. A copy of each of the listed references is also enclosed.

Although the information submitted herewith may be "material" to the Examiner's consideration of the subject application, this submission is not intended to constitute an admission that such information is "prior art" as to the claimed invention.

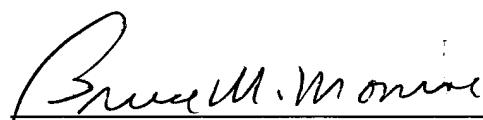
In accordance with 37 C.F.R. § 1.97(g), the filing of this Information Disclosure Statement shall not be construed to mean that a search has been made.

References 2001042509 and 2001042510 are not in the English language, but an English abstract thereof is attached to the copy of the reference submitted herewith.

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This Information Disclosure Statement is being filed within three months of the filing date of the above-referenced application. No first Official Action has yet been received and it is presumed that none has yet been mailed. No fee or certification is required. 37 C.F.R. § 1.97(b).

Respectfully submitted,



Bruce M. Monroe  
Reg. No. 33,602  
Attorney for Applicant

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JUN 11 2002  
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Enclosures:

PTO Form 1449  
Copy of (24) References

Dated: April 3, 2002  
P.O. Box 7228  
Wilmington, Delaware 19803  
(302) 479-9470

The Assistant Commissioner for Patents is hereby authorized to charge payment to Deposit Account No. **18-0350** of any fees associated with this communication.

I hereby certify that this correspondence is being deposited with the United States Postal Service as first class mail in an envelope addressed to: Assistant Commissioner for Patents, Washington, D.C. 20231 on: APRIL 3, 2002

  
RUTH CURRAN

Sheet 1 of 1

FORM PTO-1449 (Rev. 2-32)	U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE  Information Disclosure Statement by Applicant  APR 08 2002 (Use several sheets if necessary)	ATTY. DOCKET NO.	SERIAL NO
		KPG-5045US	10/044,261
		APPLICANT Kitson	
FILING DATE	GROUP		
January 10, 2002		2854	

## U.S. PATENT DOCUMENTS

Exmr Initial		Document Number	Date	Name	Class	Sub Class	Filing Date
		4,532,005	7/1985	Grieco et al.	216	47	
		4,708,925	11/1987	Newman	430	270	
		5,563,011	10/1996	Shipley	430	7	
		5,609,995	3/1997	Akram et al.	430	327	
		6,294,311 B1	9/2001	Shimazu et al.	430	271.1	
		6,352,811 B1	3/2002	Patel et al.	430	270.1	
		6,352,812 B1	3/2002	Shimazu et al.	430	273.1	
		6,358,669 B1	3/2002	Savariar-Hauck et al.	430	273.1	

## FOREIGN PATENT DOCUMENTS

Exmr Initial		Document Number	Date	Country	Class	Sub Class	Translation YES   NO
		0 708 372 A1	4/1996	EP			
		0 823 327 A2	2/1998	EP			
		0 864 420 A1	9/1998	EP			
		0 908 305 A1	4/1999	EP			
		0 908 307 A2	4/1999	EP			
		0 908 779 A1	4/1999	EP			
		0 908 784 A1	4/1999	EP			
		0 940 266 A1	9/1999	EP			
		0 950 518 A1	10/1999	EP			
		0 960 728 A1	12/1999	EP			
		1 023 994 A1	8/2000	EP			
		1 245 924	2/1972	GB			
		2001042509	2/2001	JP (English Abstract provided)			
		2001042510	2/2001	JP (English Abstract provided)			X

## OTHER DOCUMENTS

(Including Author, Title, Date, Pertinent Pages, Etc.)

		"Diazonaphthoquinone-based Resists," R. Dammel, pp. 104-106, SPIE, 1993
		"Positive Resists Based on Diazonaphthoquinones," in Photoreactive Polymers, A. Reiser, pp. 179-225, Wiley, 1989

Examiner	Date Considered

Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.